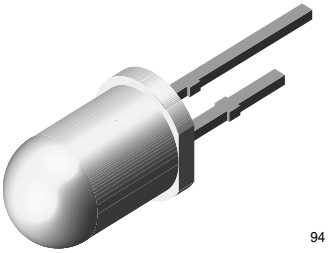
Infrared Emitting Diode, 950 nm, GaAs



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FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm): Ø 5
- Peak wavelength: λ_p = 950 nm
- High reliability
- Angle of half intensity: φ = ± 15°
- Low forward voltage
- Suitable for high pulse current operation
- Good spectral matching with Si photodetectors
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE
GREEN (5-2008)

DESCRIPTION

TSUS6202 is an infrared, 950 nm emitting diode in GaAs technology molded in a blue-gray tinted plastic package.

APPLICATIONS

- Emitter in transmissive sensors
- Emitter in reflective sensors

PRODUCT SUMMARY				
COMPONENT	I_e (mW/sr)	φ (deg)	λ_P (nm)	t_r (ns)
TSUS6202	30	± 15	950	800

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TSUS6202	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	5	V
Forward current		I_F	150	mA
Peak forward current	t_p/T = 0.5, t_p = 100 µs	I_{FM}	300	mA
Surge forward current	t_p = 100 µs	I_{FSM}	2.5	A
Power dissipation		P_V	170	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	-40 to +85	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	t ≤ 5 s, 2 mm from case	T_{sd}	260	°C
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R_{thJA}	230	K/W

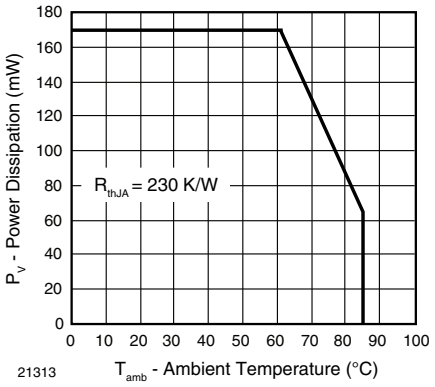


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

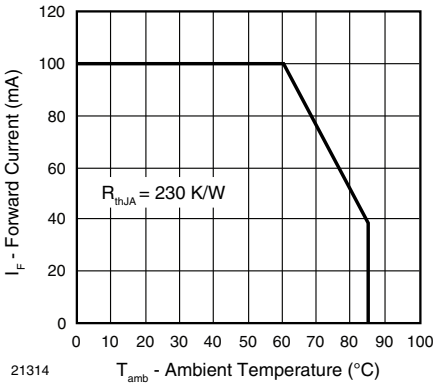


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Forward voltage	I_F = 100 mA, t_p = 20 ms	V_F	-	1.3	1.7	V
	I_F = 1.5 A, t_p = 100 µs	V_F	-	2.2	2.7	V
Temperature coefficient of V_F	I_F = 100 mA	TK_{VF}	-	-1.3	-	mV/K
Reverse current	V_R = 5 V	I_R	-	-	100	µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0	C_j	-	30	-	pF
Radiant intensity	I_F = 100 mA, t_p = 20 ms	I_e	20	30	70	mW/sr
	I_F = 1.5 A, t_p = 100 µs	I_e	170	280	-	mW/sr
Radiant power	I_F = 100 mA, t_p = 20 ms	ϕ_e	-	15	-	mW
Temperature coefficient of ϕ_e	I_F = 20 mA	$TK\phi_e$	-	-0.8	-	%/K
Angle of half intensity		φ	-	± 15	-	deg
Peak wavelength	I_F = 100 mA	λ_p	-	950	-	nm
Spectral bandwidth	I_F = 100 mA	$\Delta\lambda$	-	50	-	nm
Temperature coefficient of λ_p	I_F = 100 mA	$TK\lambda_p$	-	0.2	-	nm/K
Rise time	I_F = 100 mA	t_r	-	800	-	ns
	I_F = 1.5 A	t_r	-	400	-	ns
Fall time	I_F = 100 mA	t_f	-	800	-	ns
	I_F = 1.5 A	t_f	-	400	-	ns
Virtual source diameter		d	-	3.8	-	mm

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

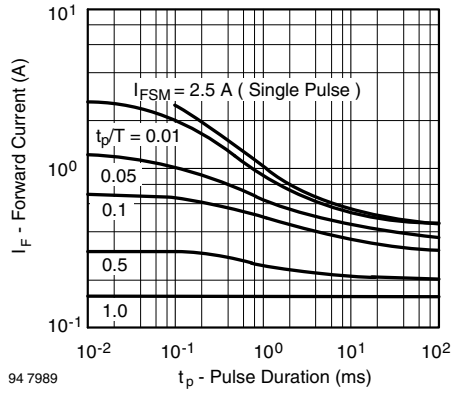


Fig. 3 - Pulse Forward Current vs. Pulse Duration

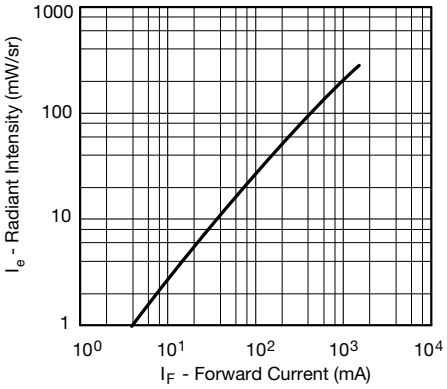


Fig. 6 - Radiant Intensity vs. Forward Current

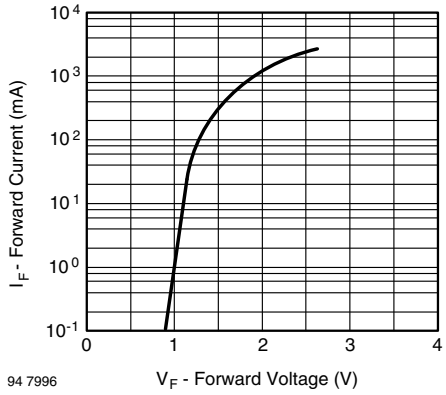


Fig. 4 - Forward Current vs. Forward Voltage

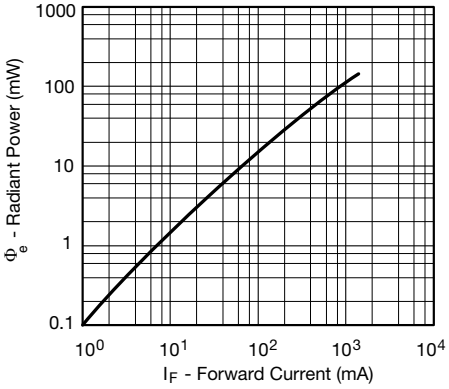


Fig. 7 - Radiant Power vs. Forward Current

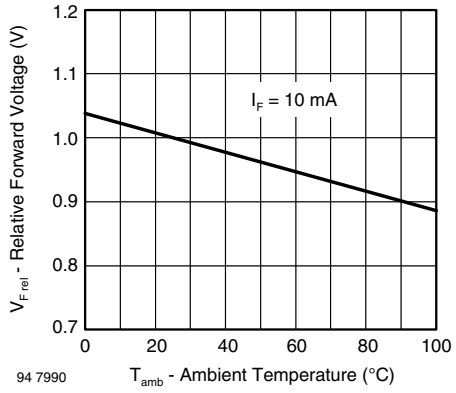


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

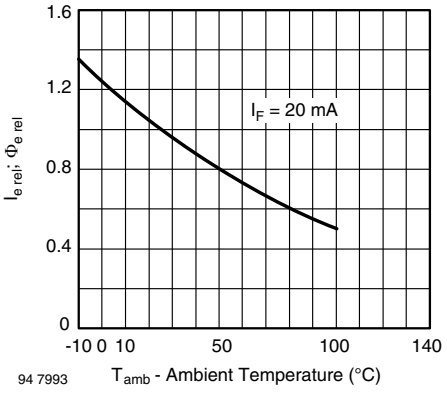


Fig. 8 - Relative Radiant Intensity/Power vs. Ambient Temperature

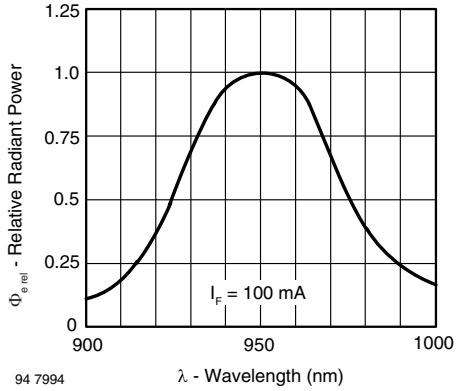


Fig. 9 - Relative Radiant Power vs. Wavelength

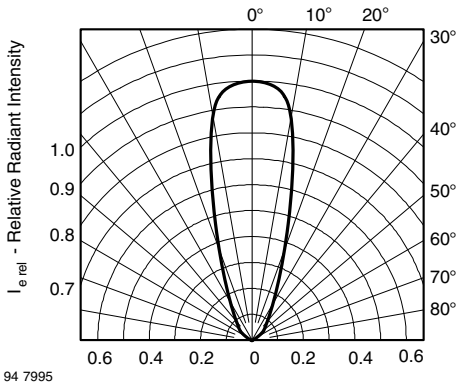
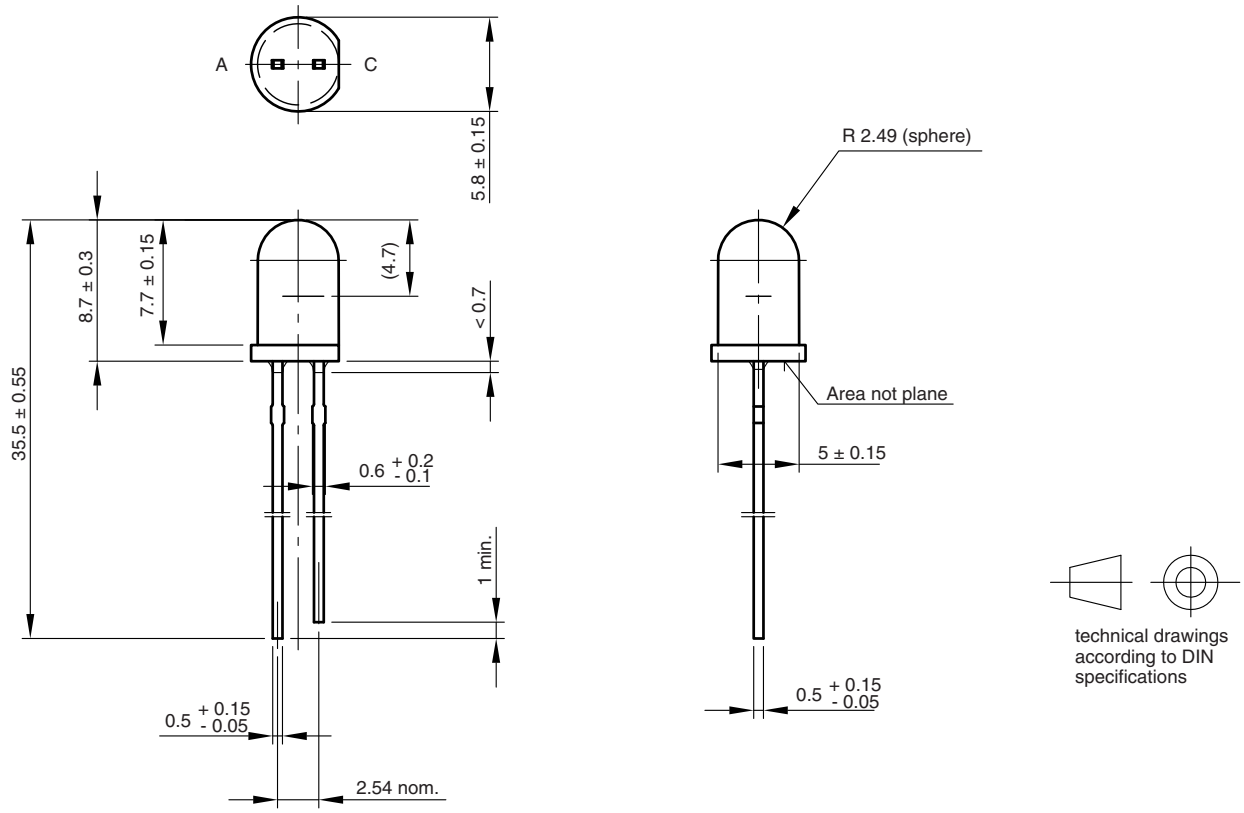


Fig. 10 - Relative Radiant Intensity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters



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